

**EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -**  
**Wholesale and Retail**

**Fast Thyristor Type FDT32-320-24**

Low switching losses  
 Distributed amplified gate for high  $dI_T/dt$

|   |                  |                           |            |      |      |
|---|------------------|---------------------------|------------|------|------|
| Mean on-state current                   | I <sub>TAV</sub> | 320 A                     |            |      |      |
| Repetitive peak off-state voltage       | V <sub>DRM</sub> |                           |            |      |      |
| Repetitive peak reverse voltage         | V <sub>RRM</sub> | 1600...2400 V             |            |      |      |
| Turn-off time                           | t <sub>q</sub>   | 25.0, 32.0, 40.0, 50.0 μs |            |      |      |
| V <sub>DRM</sub> , V <sub>RRM</sub> , V | 1600             | 1800                      | 2000       | 2200 | 2400 |
| Voltage code                            | 16               | 18                        | 20         | 22   | 24   |
| T <sub>j</sub> , °C                     |                  |                           | -60...+125 |      |      |

**MAXIMUM ALLOWABLE RATINGS**

| Symbols and parameters              |  | Units                            | Values                                       | Test conditions  |   |
|-------------------------------------|--|----------------------------------|--|--|---|
| <b>ON-STATE</b>                     |  |                                  |  |  |   |
| I <sub>TAV</sub>                    | Maximum allowable mean on-state current                                | A                                | 320<br>459                                   | T <sub>c</sub> = 85 °C; Double side cooled;<br>T <sub>c</sub> = 55 °C; Double side cooled;<br>180° half-sine wave; 50 Hz |   |
| I <sub>TRMS</sub>                   | RMS on-state current   | A                                | 502  | T <sub>c</sub> = 85 °C; Double side cooled;<br>180° half-sine wave; 50 Hz  |   |
| I <sub>TSM</sub>                    | Surge on-state current   | kA                               | 6.0<br>7.0                                   | T <sub>j</sub> =T <sub>j max</sub><br>T <sub>j</sub> =25 °C  | 180° half-sine wave;<br>t <sub>p</sub> =10 ms; single pulse;<br>V <sub>D</sub> =V <sub>R</sub> =0 V;<br>Gate pulse: I <sub>G</sub> =I <sub>FGM</sub> ; V <sub>G</sub> =20 V;<br>t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt=1 A/μs  |
|                                     |  |                                  | 6.5<br>7.5                                   | T <sub>j</sub> =T <sub>j max</sub><br>T <sub>j</sub> =25 °C  | 180° half-sine wave;<br>t <sub>p</sub> =8.3 ms; single pulse;<br>V <sub>D</sub> =V <sub>R</sub> =0 V;<br>Gate pulse: I <sub>G</sub> =I <sub>FGM</sub> ; V <sub>G</sub> =20 V;<br>t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt=1 A/μs |
| I <sup>2</sup> t                    | Safety factor  | A <sup>2</sup> s·10 <sup>3</sup> | 180<br>240                                   | T <sub>j</sub> =T <sub>j max</sub><br>T <sub>j</sub> =25 °C  | 180° half-sine wave;<br>t <sub>p</sub> =10 ms; single pulse;<br>V <sub>D</sub> =V <sub>R</sub> =0 V;<br>Gate pulse: I <sub>G</sub> =I <sub>FGM</sub> ; V <sub>G</sub> =20 V;<br>t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt=1 A/μs  |
|                                     |  |                                  | 170<br>230                                   | T <sub>j</sub> =T <sub>j max</sub><br>T <sub>j</sub> =25 °C  | 180° half-sine wave;<br>t <sub>p</sub> =8.3 ms; single pulse;<br>V <sub>D</sub> =V <sub>R</sub> =0 V;<br>Gate pulse: I <sub>G</sub> =I <sub>FGM</sub> ; V <sub>G</sub> =20 V;<br>t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt=1 A/μs |
| <b>BLOCKING</b>                     |  |                                  |  |  |   |
| V <sub>DRM</sub> , V <sub>RRM</sub> | Repetitive peak off-state and Repetitive peak reverse voltages         | V                                | 1600...2400                                  | T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ;<br>180° half-sine wave; 50 Hz;<br>Gate open                    |   |
| V <sub>DSM</sub> , V <sub>RSM</sub> | Non-repetitive peak off-state and Non-repetitive peak reverse voltages | V                                | 1700...2500                                  | T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ;<br>180° half-sine wave; single pulse; Gate open                |   |
| V <sub>D</sub> , V <sub>R</sub>     | Direct off-state and Direct reverse voltages                           | V                                | 0.6·V <sub>DRM</sub><br>0.6·V <sub>RRM</sub> | T <sub>j</sub> =T <sub>j max</sub> ;<br>Gate open  |   |

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| TRIGGERING         |  |                  |            |  |
|--------------------|--|------------------|------------|--|
| $I_{FGM}$          | Peak forward gate current  | A                | 6          | $T_j = T_{j \max}$   |
| $V_{RGM}$          | Peak reverse gate voltage  | V                | 5          |  |
| $P_G$              | Gate power dissipation   | W                | 3          | $T_j = T_{j \max}$ for DC gate current   |
| SWITCHING          |  |                  |            |  |
| $(di_T/dt)_{crit}$ | Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz) | A/ $\mu$ s       | 1600       | $T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 \cdot I_{TAV};$<br>Gate pulse: $I_G = 2$ A; $V_G = 20$ V;<br>$t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ $\mu$ s |
| THERMAL            |  |                  |            |  |
| $T_{stg}$          | Storage temperature  | °C               | -60...+50  |  |
| $T_j$              | Operating junction temperature                                       | °C               | -60...+125 |  |
| MECHANICAL         |  |                  |            |  |
| F                  | Mounting force   | kN               | 9.0...11.0 |  |
| a                  | Acceleration   | m/s <sup>2</sup> | 50         | Device clamped   |

## CHARACTERISTICS

| Symbols and parameters |   | Units      | Values                 | Conditions  |   |
|------------------------|---|------------|------------------------|---|---|
| <b>ON-STATE</b>        |   |            |                        |   |   |
| $V_{TM}$               | Peak on-state voltage, max  | V          | 2.80                   | $T_j = 25$ °C; $I_{TM} = 1005$ A  |   |
| $V_{T(TO)}$            | On-state threshold voltage, max                                     | V          | 1.50                   | $T_j = T_{j \max};$   |   |
| $r_T$                  | On-state slope resistance, max                                      | mΩ         | 2.050                  | $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$                                       |   |
| $I_H$                  | Holding current, max  | mA         | 500                    | $T_j = 25$ °C;<br>$V_D = 12$ V; Gate open                                       |   |
| <b>BLOCKING</b>        |   |            |                        |   |   |
| $I_{DRM}, I_{RRM}$     | Repetitive peak off-state and Repetitive peak reverse currents, max | mA         | 50                     | $T_j = T_{j \max};$<br>$V_D = V_{DRM}; V_R = V_{RRM}$                           |   |
| $(dv_D/dt)_{crit}$     | Critical rate of rise of off-state voltage <sup>1)</sup> , min      | V/ $\mu$ s | 200, 320, 500, 1000    | $T_j = T_{j \max};$<br>$V_D = 0.67 \cdot V_{DRM};$ Gate open                    |   |
| <b>TRIGGERING</b>      |   |            |                        |   |   |
| $V_{GT}$               | Gate trigger direct voltage, max                                    | V          | 4.00<br>2.50<br>2.00   | $T_j = T_{j \min}$<br>$T_j = 25$ °C<br>$T_j = T_{j \max}$                       | $V_D = 12$ V; $I_D = 3$ A;<br>Direct gate current   |
| $I_{GT}$               | Gate trigger direct current, max                                    | mA         | 500<br>300<br>200      | $T_j = T_{j \min}$<br>$T_j = 25$ °C<br>$T_j = T_{j \max}$                       |   |
| $V_{GD}$               | Gate non-trigger direct voltage, min                                | V          | 0.25                   | $T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM};$                                   |   |
| $I_{GD}$               | Gate non-trigger direct current, min                                | mA         | 10.00                  | Direct gate current   |   |
| <b>SWITCHING</b>       |   |            |                        |   |   |
| $t_{gd}$               | Delay time, max   | $\mu$ s    | 0.66                   | $T_j = 25$ °C; $V_D = 1000$ V; $I_{TM} = I_{TAV};$<br>$di/dt = 200$ A/ $\mu$ s; |   |
| $t_{gt}$               | Turn-on time <sup>2)</sup> , max                                    | $\mu$ s    | 1.60, 2.00, 2.50, 3.20 |   |   |
| $t_q$                  | Turn-off time <sup>3)</sup> max                                     | $\mu$ s    | 25.0, 32.0, 40.0, 50.0 | $dv_D/dt = 50$ V/ $\mu$ s   | $T_j = T_{j \max};$<br>$I_{TM} = I_{TAV};$<br>$di_R/dt = -10$ A/ $\mu$ s;<br>$V_R = 100$ V;<br>$V_D = 0.67 V_{DRM}$ |
|                        |   |            | 32.0, 40.0, 50.0, 63.0 | $dv_D/dt = 200$ V/ $\mu$ s  |   |

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| THERMAL      |   |                             |        |                |                     |
|--------------|---|-----------------------------|--------|----------------|---------------------|
| $R_{thjc}$   | Thermal resistance, junction to case, max | $^{\circ}\text{C}/\text{W}$ | 0.0400 | Direct current | Double side cooled  |
| $R_{thjc-A}$ |   |                             | 0.0880 |                | Anode side cooled   |
| $R_{thjc-K}$ |   |                             | 0.0720 |                | Cathode side cooled |
| $R_{thck}$   | Thermal resistance, case to heatsink, max | $^{\circ}\text{C}/\text{W}$ | 0.0060 | Direct current |                     |

| MECHANICAL |                           |              |                  |  |  |
|------------|---------------------------|--------------|------------------|--|--|
| m          | Weight, max               | g            | 92               |  |  |
| $D_s$      | Surface creepage distance | mm<br>(inch) | 10.30<br>(0.405) |  |  |
| $D_a$      | Air strike distance       | mm<br>(inch) | 6.30<br>(0.248)  |  |  |

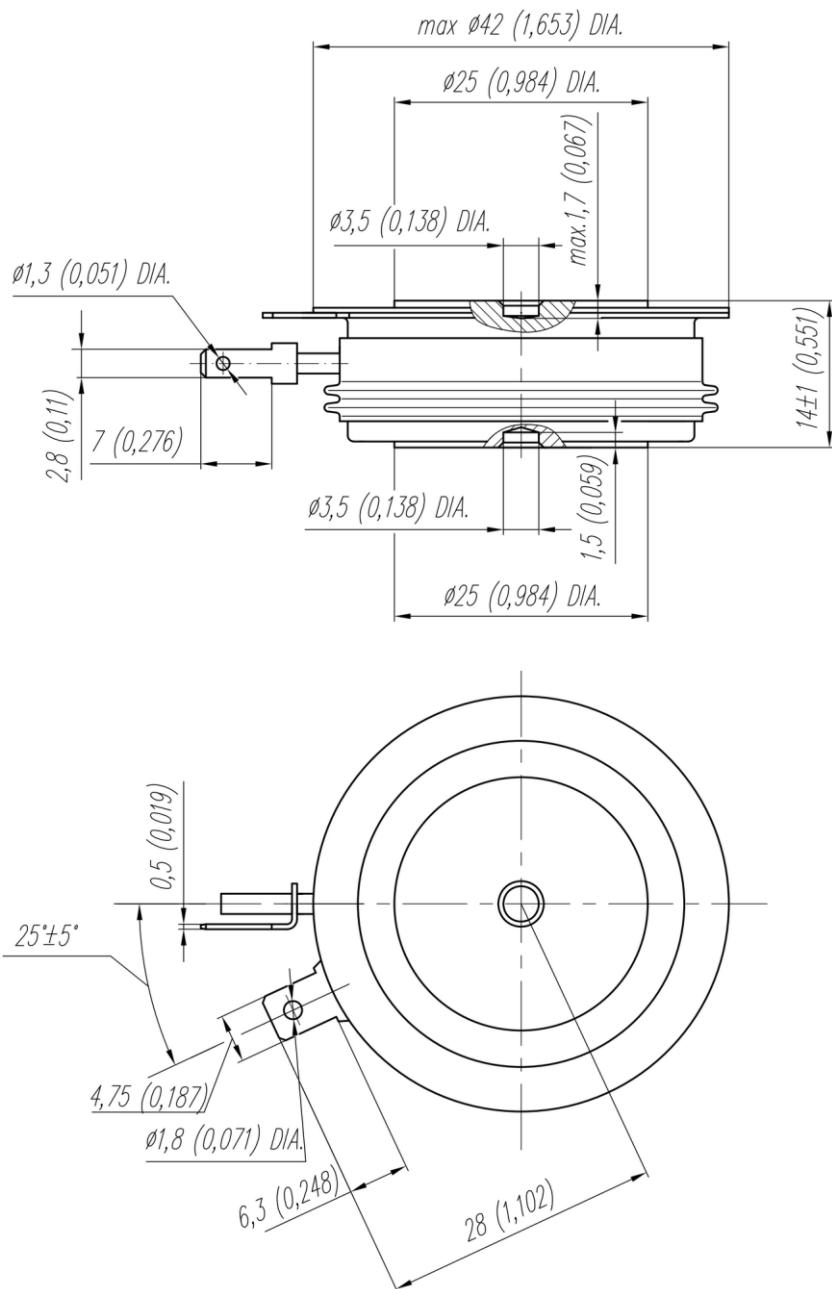
| PART NUMBERING GUIDE   |   |   |   |   |   |   | NOTES   |      |      |      |      |
|--|---|---|---|---|---|---|---|------|------|------|------|
| FDT 32 320 24 7 5 4  |   |   |   |   |   |   | 1) Critical rate of rise of off-state voltage                         |      |      |      |      |
| 1  | 2 | 3 | 4 | 5 | 6 | 7 | Symbol of group   | 4    | 5    | 6    | 7    |
|  |   |   |   |   |   |   | ( $\text{dv}_D/\text{dt}_{\text{crit}}$ , V/ $\mu\text{s}$ )          | 200  | 320  | 500  | 1000 |
| 1. FDT — Fast Disc Thyristor<br>2. Element diameter<br>3. Mean on-state current, A<br>4. Voltage code<br>5. Critical rate of rise of off-state voltage<br>6. Group of turn-off time ( $\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$ )<br>7. Group of turn-on time |   |   |   |   |   |   | 2) Turn-on time   |      |      |      |      |
|  |   |   |   |   |   |   | Symbol of group   | 6    | 5    | 4    | 3    |
|  |   |   |   |   |   |   | $t_{gt}, \mu\text{s}$   | 1.60 | 2.00 | 2.50 | 3.20 |
|  |   |   |   |   |   |   | 3) Turn-off time ( $\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$ ) |      |      |      |      |
|  |   |   |   |   |   |   | Symbol of group   | 5    | 4    | 3    | 2    |
|  |   |   |   |   |   |   | $t_q, \mu\text{s}$  | 25.0 | 32.0 | 40.0 | 50.0 |

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### OVERALL DIMENSIONS

Package type: T.B2



All dimensions in millimeters (inches)

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